





**FZT560** 

#### **500V PNP HIGH VOLTAGE TRANSISTOR IN SOT223**

#### **Features**

- BV<sub>CEO</sub> > -500V
- I<sub>C</sub> = -150mA High Continuous Current
- I<sub>CM</sub> = -500mA Peak Pulse Current
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

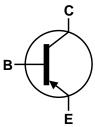
### **Mechanical Data**

- Case: SOT223
- Case Material: Molded Plastic. "Green" Molding Compound;
   UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads; Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.112 grams (Approximate)

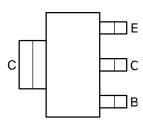
SOT223



Top View



Device Symbol



Top View Pin-Out

### Ordering Information (Notes 4 & 5)

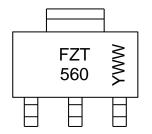
Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
FZT560TA	AEC-Q101	FZT560	7	12	1,000
FZT560QTA	Automotive	FZT560	7	12	1,000
FZT560TC	AEC-Q101	FZT560	13	12	4,000
FZT560QTC	Automotive	FZT560	13	12	4,000

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product\_compliance\_definitions/.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**

SOT223



FZT 560 = Product Type Marking Code YWW = Date Code Marking Y or  $\overline{Y}$  = Last Digit of Year (ex: 5= 2015) WW or  $\overline{W}W$  = Week Code (01~53)



**FZT560** 

# **Absolute Maximum Ratings** ( $@T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-500	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-500	V
Emitter-Base Voltage	V <sub>EBO</sub>	-7	V
Continuous Collector Current	Ic	-150	mA
Peak Pulse Current	I <sub>CM</sub>	-500	mA

## Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Power Dissipation	(Note 6)	- Г	2	W
Power Dissipation	(Note 7)	P <sub>D</sub>	3	W
Thermal Resistance, Junction to Ambient	(Note 6)	ь	62.5	°C/W
Thermal Resistance, Junction to Ambient	(Note 7)	$R_{\theta JA}$	41.7	°C/W
Thermal Resistance, Junction to Leads (Note 8)		$R_{ heta JL}$	14.8	°C/W
Operating and Storage Temperature Range		$T_{J_i} T_{STG}$	-55 to +150	°C

## ESD Ratings (Note 9)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes:

- 6. For a device mounted with the collector lead on 25mm x 25mm 2oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady-state.

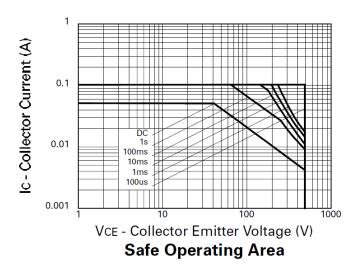
  7. Same as Note 6, except the device is mounted on 50mm x 50mm 2oz copper.

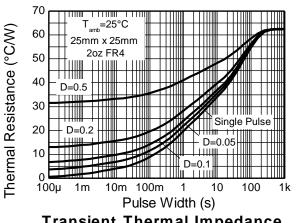
  8. Thermal resistance from junction to solder-point (at the end of the collector lead).

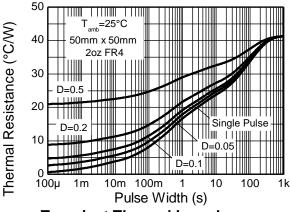
  9. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



## **Thermal Characteristics and Derating Information**

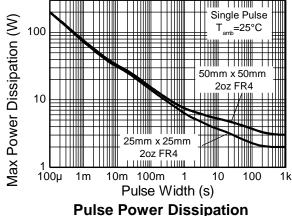


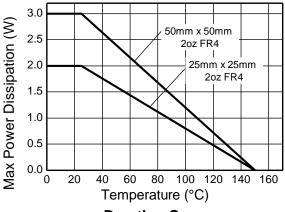




## **Transient Thermal Impedance**

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March 2015

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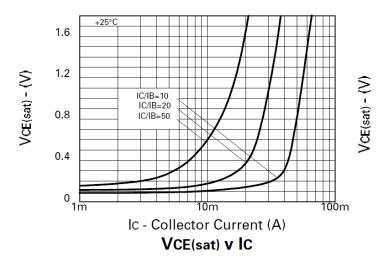
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

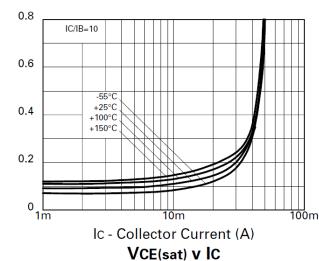
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	-500	_	_	V	$I_{C} = -100\mu A$
Collector-Emitter Breakdown Voltage (Note 10)	BV <sub>CEO</sub>	-500	_	_	V	$I_C = -1mA$
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	-7	_	-	V	$I_E = -100 \mu A$
Collector Cut-Off Current	I <sub>CBO</sub>	_	_	-100	nA	V <sub>CB</sub> = -500V
Collector Cut-Off Current	I <sub>CES</sub>	_	_	-100	nA	V <sub>CE</sub> = -500V
Emitter Cut-Off Current	I <sub>EBO</sub>	_	_	-100	nA	$V_{EB} = -5.6V$
Collector-Emitter Saturation Voltage (Note 10)	V	-	_	-200	mV	$I_C = -20mA$ , $I_B = -2mA$
Collector-Entitler Saturation Voltage (Note 10)	V <sub>CE(sat)</sub>	-	-	-500		$I_C = -50 \text{mA}, I_B = -10 \text{mA}$
Base-Emitter Saturation Voltage (Note 10)	$V_{BE(sat)}$	_	_	-900	mV	$I_C = -50 \text{mA}, I_B = -10 \text{mA}$
Base-Emitter Turn-On Voltage (Note 10)	$V_{BE(on)}$	-	_	-900	mV	$I_C = -50 \text{mA}, V_{CE} = -10 \text{V}$
		100	_	300		$I_C = -1mA$ , $V_{CE} = -10V$
DC Current Gain (Note 10)	h <sub>FE</sub>	80	_	300	_	$I_C = -50 \text{mA}, V_{CE} = -10 \text{V}$
, ,		_	15	-		I <sub>C</sub> = -100mA, V <sub>CE</sub> = -10V
Current Gain-Bandwidth Product	fτ	60	-	-	MHz	$V_{CE} = -20V$ , $I_{C} = -10mA$ f = 50MHz
Turn-On Time	ton	-	110	-	ns	$V_{CC} = -100V$ , $I_{C} = -50mA$
Turn-Off Time	t <sub>off</sub>	-	1.5	_	μs	$I_{B1} = -5mA$ , $I_{B2} = 10mA$
Output Capacitance	$C_obo$	=	=	8	pF	$V_{CB} = -20V$ , $f = 1MHz$

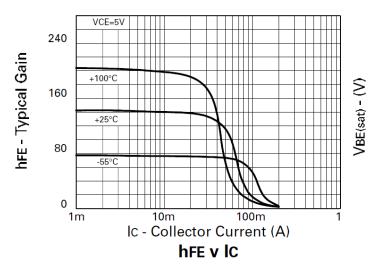
Note: 10. Measured under pulsed conditions. Pulse width  $\leq$  300  $\mu$ s. Duty cycle  $\leq$  2%.

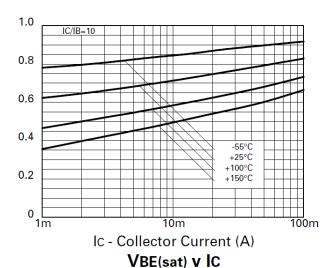


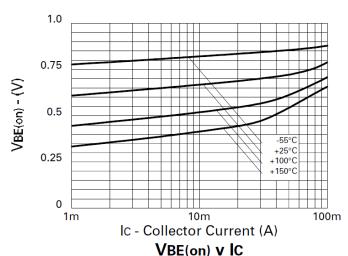
# Typical Electrical Characteristics (@TA = +25°C, unless otherwise specified.)







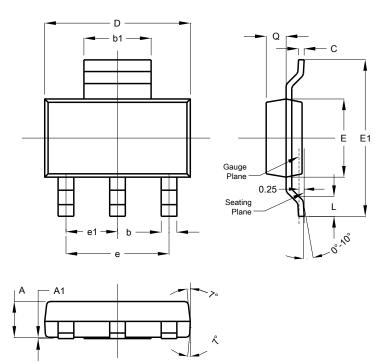






## **Package Outline Dimensions**

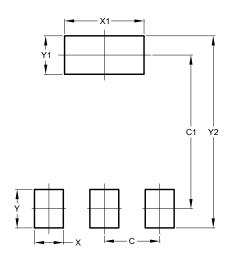
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT223						
Dim	Min	Max	Тур			
Α	1.55	1.65	1.60			
<b>A</b> 1	0.010	0.15	0.05			
b	0.60	0.80	0.70			
b1	2.90	3.10	3.00			
С	0.20	0.30	0.25			
D	6.45	6.55	6.50			
Е	3.45	3.55	3.50			
E1	6.90	7.10	7.00			
е	-	-	4.60			
e1	-	-	2.30			
L	0.85	1.05	0.95			
Q	0.84	0.94	0.89			
All Dimensions in mm						

## Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	2.30
C1	6.40
X	1.20
X1	3.30
Y	1.60
Y1	1.60
Y2	8.00

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device terminals and PCB tracking.



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